The package includes an ultra compact datalogger featuring the unique ‘SmartLink’ connector system, combined with a heatshield and thermocouple adapter to provide the number of measurement channels required.

Future upgrading or servicing is a simple and cost effective procedure, with only the Thermocouple Adapter needing to be changed to allow 6,9,12 or 16 Type-K measurement versions.

The ‘SmartLink’ concept allows high measurement channel configurations, while maintaining a small footprint and quick connection to a range of accessories for capture of profile and SPC information from reflow, wave/selective and vapour phase soldering processes.

A comprehensive suite of software includes profile analysis, data management, profile simulations and integrated SPC charting tools. This easy to use system is ideal for manufacturers and EMS providers who require rapid profile setup followed by periodic measurements to control their solder process quality.

**System Advantages**

- Compact size for profiling of narrow PCB formats or ovens with low tunnel clearance
- Support for 6 to 16 measurement channels for profiling of the most complex PCB assemblies
- Unique SmartLink connection system provides quick datalogger connection to a range of products and accessories
- Software tools including profile analysis and simulation, plus integrated SPC management features
- Connectivity via standard USB cables or 2.4Ghz Wireless Telemetry
- Extendable for control of wave / selective or vapour phase soldering
**Datalogger**

- **Size/Weight**: 125mm x 52mm x 9mm, 110g
- **Channels**: 6, 9, 12 or 16 Channel Versions Available
- **Memory**: 120,000 Memory Points
- **Sampling**: 0.1s to 10 Minutes
- **Measurement Range**: -150 to 600 °C
- **Accuracy**: ±0.5 °C
- **Resolution**: ±0.02 °C
- **Max. Internal Temperature**: +85 °C (Auto Shutdown on over temp.)
- **Power**: Rechargeable High Temperature Nimh
- **Communications**: USB (Type A - Mini B) or 2.4Ghz Wireless
- **Thermocouples**: Type K, EN 05842:1993, Class 1 / ANSI MC 96.1

**Heatshield**

- **Material**: Stainless Steel
- **Size (LxWxH)**
  - 6/9 Channel Version: 310mm x 80mm x 25mm
  - 12 Channel Version: 310mm x 104mm x 25mm
  - 16 Channel Version: 330mm x 146mm x 25mm

**Technical Data**

**Thermal Protection Duration**

<table>
<thead>
<tr>
<th>Temperature (°C)</th>
<th>Survival Time (Minutes)</th>
</tr>
</thead>
<tbody>
<tr>
<td>100°C</td>
<td>5</td>
</tr>
<tr>
<td>150°C</td>
<td>10</td>
</tr>
<tr>
<td>200°C</td>
<td>15</td>
</tr>
<tr>
<td>250°C</td>
<td>20</td>
</tr>
<tr>
<td>300°C</td>
<td>25</td>
</tr>
</tbody>
</table>

Other heatshield sizes are available for special process requirements.

**Standard Equipment**

- SolderStar PRO datalogger
- Thermocouple Adapter
- 25mm Lead Free capable heatshield
- Type K thermocouples
- PC Analysis software
- Hard copy manual + 1 Year calibration certificate
- Equipment case

**Optional Reflow Equipment**

- AUTOSeeker Profiler Optimisation software
- 2.4Ghz Wireless Telemetry
- Deltaprobe Oven Verification fixture
- Adjustable Reflow Carrier

**Wireless Telemetry Option**

- **Frequency**: 2.4GHZ Transceiver
- **Channels**: 128 Individual Channels
- **Protocol**: Zigbee PRO - Duplex Transmission

**Software**

- **Compatibility**: Windows™ XP Vista/Windows 7/8/10 32 & 64 Bit
- **Language Support**: English, French, German, Italian, Portuguese, Spanish & Chinese

For demonstration software visit www.solderstar.com

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For more information contact your regional Solderstar office

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Specifications subject to change without notification.